

(1,27 mm) .050"

SEAM SERIES

5, 8 and 10 row footprint

HIGH SPEED/HIGH DENSITY OPEN PIN

Pins

Up to 500

SPECIFICATIONS

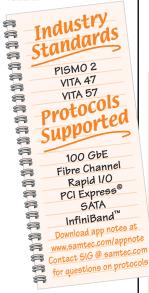
For complete specifications and recommended PCB layouts see www.samtec.com?SEAM

Insulator Material: Contact Material: Copper Alloy Operating Temp Range: -55°C to +125°C (7 mm stack height): 1.8 A per pin (10 adjacent pins powered) Plating: Au or Sn over 50μ" (1,27 μm) Ni Contact Resistance: 5.5 mΩ Working Voltage: 240 VAC RoHS Compliant: Yes Lead-Free Solderable: Yes

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





ı	MATED HEIGHTS					
SEAM	// SEAF LEAD STYLE					
LEAD STYLE	-05.0	-06.0	-06.5			
-02.0	7 mm	8 mm	8.5 mm			
-03.0	8 mm	9 mm	9.5 mm			
-03.5	8.5 mm	9.5 mm	10 mm			
-06.5	11.5 mm	12.5 mm	13 mm			
-07.0	12 mm	13 mm	13.5 mm			
-09.0	14 mm	15 mm	15.5 mm			
-11.0	16 mm	17 mm	17.5 mm			

Mates with: SEAF, SEAFP

Note: Patented

Note: Some sizes. styles and options are non-standard, non-returnable.



(1,15 mm) .045" NOMINAL compatible with SamArrav®. WIPE Samples recommended. Solder charges Low Insertion/ Extraction **Forces**

SEAM/SEAF		Rated @ 3dB Insertion Loss		
ı	10 mm Stack Height	w/o PCB effects*		
	Single-Ended Signaling	18 GHz / 36 Gbps		
ı	Differential Pair Signaling	18 GHz / 36 Gbps		

*Test board losses de-embedded from performance data.

Performance data for other stack heights and complete test data available at www.samtec.com?SEAM or contact sig@samtec.com

Т

Gbps

NO. PINS SEAMI PER ROW

LEAD STYLE

LEAD

STYLE

from

chart

PLATING OPTION

= 10µ"

(0,25 µm)

Gold on

ontact area

Matte Tin on

solder tail

-S

 $= 30 \mu$ "

(0,76 µm)

Gold on

contact area

Matte Tin on

solder tail

NO. OF **ROWS**

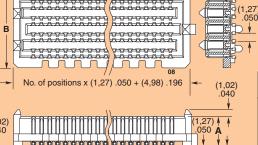
SOLDER TYPE

-10, –15, –20, -30, –40, –50

10 only ávailablé in 04 row) -15 only available in 10 row

NO. OF ROWS	В	
-04	(7,06) .278	
-05, -06	(9,60) .378	
-08	(12,14) .478	
40	(14.00) 570	

(14,68) .578



(1,02) (0.86)(1,12) .044-> DIA (0,10) DIA No. of positions x (1,27) .050 + (3,58) .141

-04=Four Rows (-06.5 not available)

-05 =Five Rows (-06.5 not available)

-06=Six Rows (-06.5 not available)

-08 =Eight Rows -10

=Ten Rows

LEAD Α STYLE -02.0 (4,60) .181 (5,59) .220 -03.0 -03.5 (6,10) .240 -06.5 (6,40) .252 -07.0 (9.60) .378 -09.0 (11,60) .457 **-11.0** (13,60) .535

-1 = Tin/Lead Alloy Solder Charge

-2 = Lead-Free Solder Charge = Alignment Pins (Required. Arrays will not self-center on solder pads)

= Polyimide film Pick & Place Pad

–TR =Tape & Reel

DIFFERENTIAL

• •	←(1,27) .050 ○ ○ ● ●	ARRAY	PAIR COUNT
.050	0000	40x8	80
0 0	$\bullet \bullet \circ \circ$	40x6	60
— ••	0000	30x10	75
	, PAIR COUNT	30x8	60
ARRAY		30x6	45
50x10	125	20x10	50
50x8	100	20x8	40
40x10	100	20x5	25

Due to technical progress, all designs, specifications and components are subject to change without notice.

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